

PSMN8R5-40HS

N-channel 40 V, 8.5 mOhm, standard level MOSFET in LFPAK56D using TrenchMOS technology

26 September 2022

Product data sheet

1. General description

Dual standard level N-channel MOSFET in an LFPAK56D (Dual Power-SO8) package using TrenchMOS technology.

2. Features and benefits

- Dual MOSFET
- Repetitive avalanche rated
- · High reliability LFPAK56D package
- Copper-clip, solder die attach
- Qualified to 175 °C

3. Applications

- · Brushless DC motor control
- DC-to-DC converters
- · High-performance synchronous rectification
- · High performance and high efficiency server power supply

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	30	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	53	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics FET1 and FET2		'	'			
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 25 °C; Fig. 11		-	7	8.5	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 175 °C; Fig. 11; Fig. 12		-	13.8	16.7	mΩ
Dynamic ch	naracteristics FET1 and FE	T2	•				
Q _{GD}	gate-drain charge	I _D = 15 A; V _{DS} = 32 V; V _{GS} = 10 V;		-	7.8	-	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u>		-	21.8	-	nC
Avalanche	ruggedness FET1 and FET	2		'	·		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$I_D = 30 \text{ A}; V_{sup} \le 40 \text{ V}; V_{GS} = 10 \text{ V}; $ $T_{j(init)} = 25 \text{ °C}; Fig. 4$	[2] [3]	-	-	84	mJ



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-drain d	iode FET1 and FET2					
Q _r		I_S = 15 A; dI_S/dt = -100 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V; T_j = 25 °C	-	11.7	-	nC

- [1] Continuous current is limited by package.
- [2] Refer to application note AN10273 for further information
- [3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	S1	source1	8 7 6 5		
2	G1	gate1	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	D1 D1 D2 D2	
3	S2	source2			
4	G2	gate2			
5	D2	drain2			
6	D2	drain2			
7	D1	drain1		S1 G1 S2 G2	
8	D1	drain1	LFPAK56D; Dual LFPAK (SOT1205)	mbk725	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN8R5-40HS	LFPAK56D; Dual LFPAK	plastic, single ended surface mounted package (LFPAK56D); 8 leads	SOT1205			

7. Marking

Table 4. Marking codes

Type number	Marking code
PSMN8R5-40HS	8R5S40H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V_{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$		-	40	V
V_{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	53	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	30	Α
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>	[1]	-	30	Α

Symbol	Parameter	Conditions		Min	Max	Unit
I _{DM}	peak drain current	pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 \text{ °C}$; Fig. 3		-	225	Α
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drain	n diode FET1 and FET2		,	'		
Is	source current	T _{mb} = 25 °C	[1]	-	30	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C		-	225	Α
Avalanche ru	uggedness FET1 and FET2					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$I_D = 30 \text{ A; } V_{sup} \le 40 \text{ V; } V_{GS} = 10 \text{ V;}$ $T_{j(init)} = 25 \text{ °C; } Fig. 4$	[2] [3]	-	84	mJ

- [1] Continuous current is limited by package.
- [2] Refer to application note AN10273 for further information
- [3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

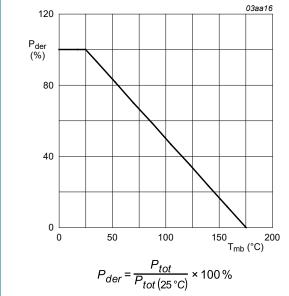


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

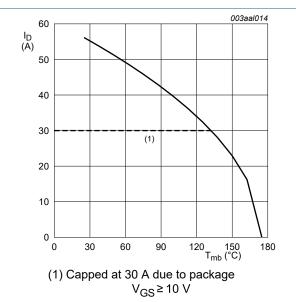


Fig. 2. Continuous drain current as a function of mounting base temperature

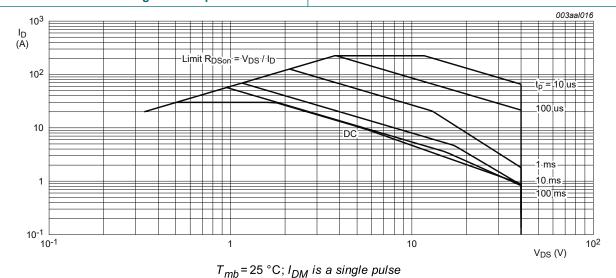
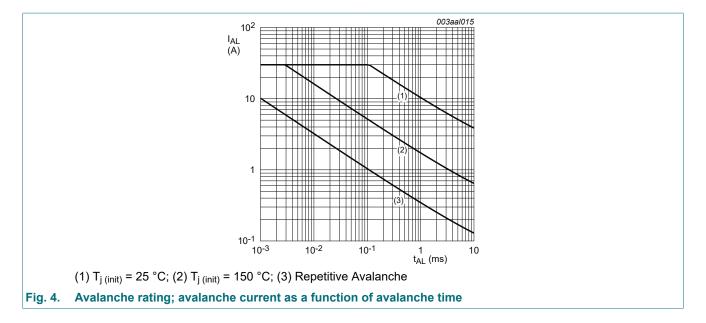


Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

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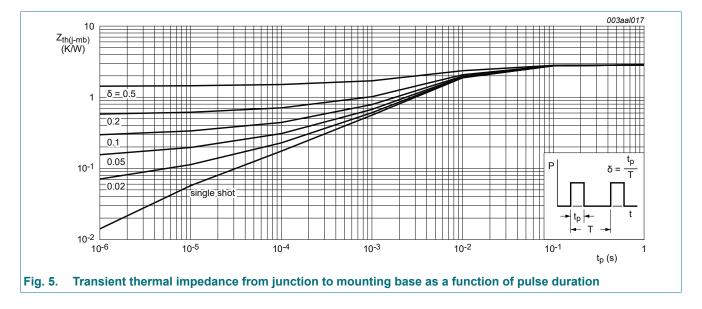
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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 5	-	-	2.84	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	Minimum footprint; mounted on a printed circuit board	-	95	-	K/W



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics FET1 and FET2					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 9;$ Fig. 10	2.4	3	4	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 9</u> ; <u>Fig. 10</u>	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; Fig. 9;$ Fig. 10	-	-	4.5	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μΑ
I _{GSS} gate lea	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_{D} = 15 A; T_{j} = 25 °C; Fig. 11	-	7	8.5	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 175 °C; Fig. 11; Fig. 12	-	13.8	16.7	mΩ
Dynamic ch	naracteristics FET1 and FE	:T2				
Q _{G(tot)}	total gate charge	I _D = 15 A; V _{DS} = 32 V; V _{GS} = 10 V;	-	21.8	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u>	-	5.9	-	nC
Q_{GD}	gate-drain charge		-	7.8	-	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;	-	1079	1439	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	-	235	282	pF
C _{rss}	reverse transfer capacitance		-	149	204	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 32 \text{ V}; R_L = 2.4 \Omega; V_{GS} = 10 \text{ V};$	-	7.4	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	12	-	ns
t _{d(off)}	turn-off delay time		-	13.8	-	ns
t _f	fall time		-	10.3	-	ns
Source-dra	in diode FET1 and FET2					
V_{SD}	source-drain voltage	I _S = 15 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 16</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	$I_S = 15 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$; $V_{GS} = 0 \text{ V}$;	-	20.3	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C	-	11.7	-	nC

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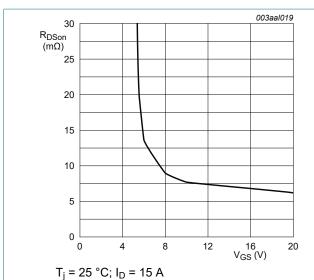


Fig. 6. Drain-source on-state resistance as a function of gate-source voltage; typical values

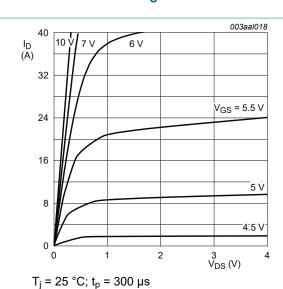


Fig. 7. Output characteristics; drain current as a function of drain-source voltage; typical values

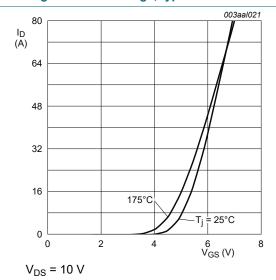


Fig. 8. Transfer characteristics; drain current as a function of gate-source voltage; typical values

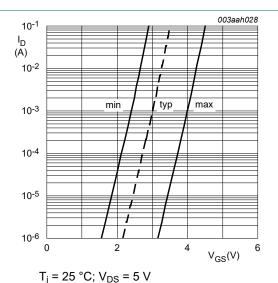


Fig. 9. Sub-threshold drain current as a function of gate-source voltage

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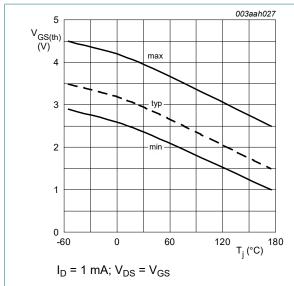


Fig. 10. Gate-source threshold voltage as a function of junction temperature

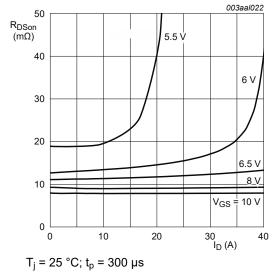


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

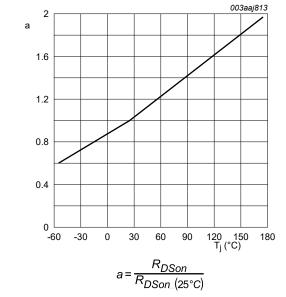


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

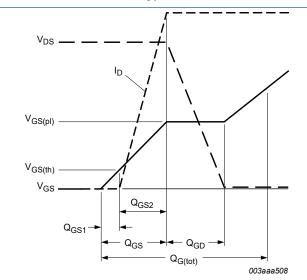


Fig. 13. Gate charge waveform definitions

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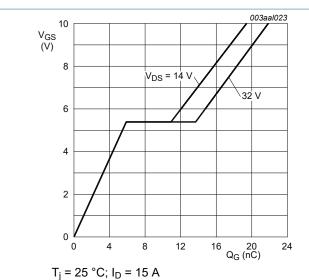


Fig. 14. Gate-source voltage as a function of gate charge; typical values

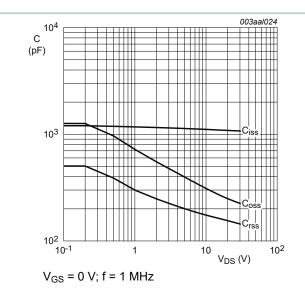


Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

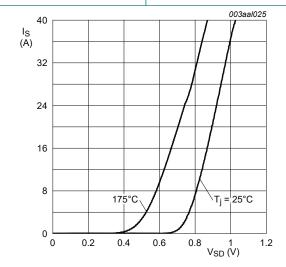


Fig. 16. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

 $V_{GS} = 0 V$

11. Package outline

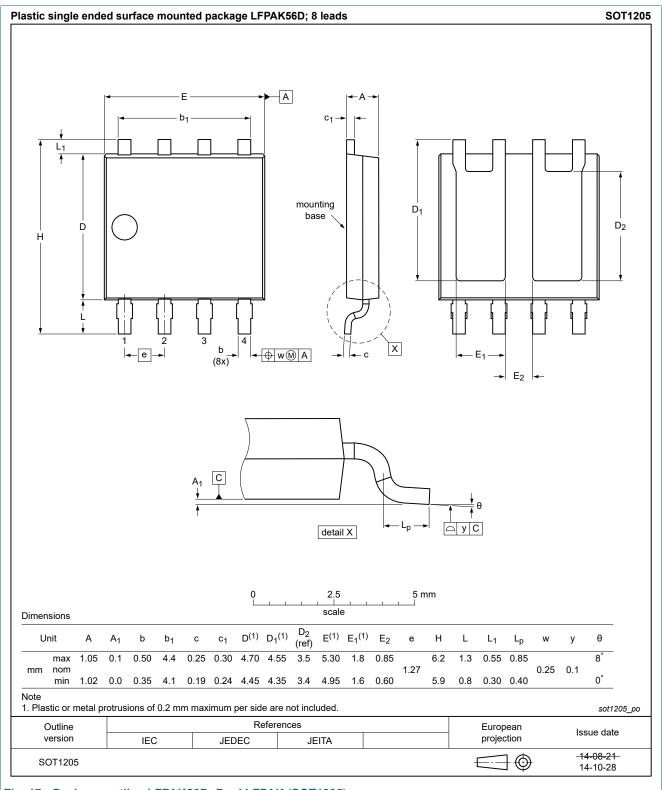
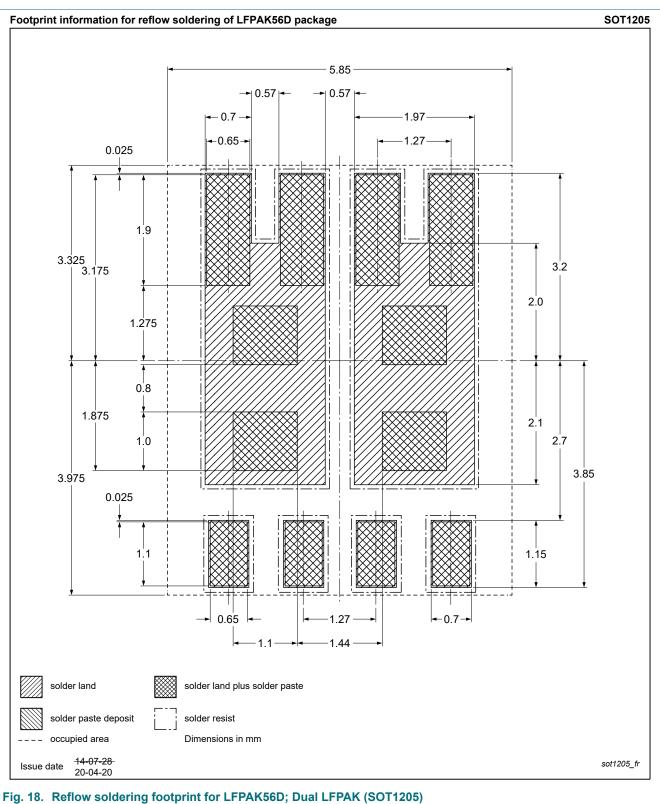


Fig. 17. Package outline LFPAK56D; Dual LFPAK (SOT1205)

12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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